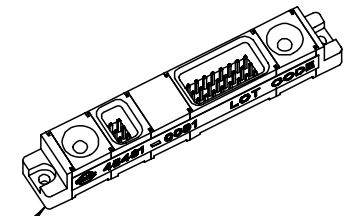


NOTES:

1. MATERIAL: LCP, GLASS FILLED, UL94V-0, BLACK.
CONTACTS: COPPER ALLOY
2. FINISH: SELECT GOLD: 30 MI MIN.
SELECT TIN: 100 MI MIN.
BOTH OVER NICKEL.
3. PRODUCT SPECIFICATION: PS-45424-001.
4. PACKAGING SPECIFICATION: PK-45481-001.



MODULE 1

PD 500	PD 502	PD 312	PD 513	PD 300	PD 502	PD 501
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PCB LAYOUT: COMPONENT SIDE
PCB THICKNESS: .125/3.18
PCB TOLERANCE: ±.002/0.05

EC NO: UCP2006-0519	DRWN: ADRA TNL2005/09/12	CHKD: 2005/09/15	APPR: APATEL 2005/09/15
A	REV	DESCRIPTION	QUALITY SYMBOLS

QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	
	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± .010
2 PLACES	± 0.25	± .015
1 PLACE	± 0.38	± ---
ANGULAR ±1/2°		
DRAFT WHERE APPLICABLE		
MUST REMAIN WITHIN DIMENSIONS		

SCALE 1:1.25	DESIGN UNITS METRIC
DIMENSION STYLE IN/MM	
DRAWN BY SCHAFFER	DATE 2004/04/01
CHECKED BY SAMIEC	DATE 2004/04/01
APPROVED BY MARGULIS	DATE 2004/04/01

THIRD ANGLE PROJECTION	REVISE ON CAD ONLY
TITLE POWER DOCK ASSEMBLY POWER VERTICAL SOLDER TAIL	
molex MOLEX INCORPORATED	
MATERIAL NO. 45481-0091	DOCUMENT NO. SD-45481-091
SHEET NO. 1 OF 1	

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